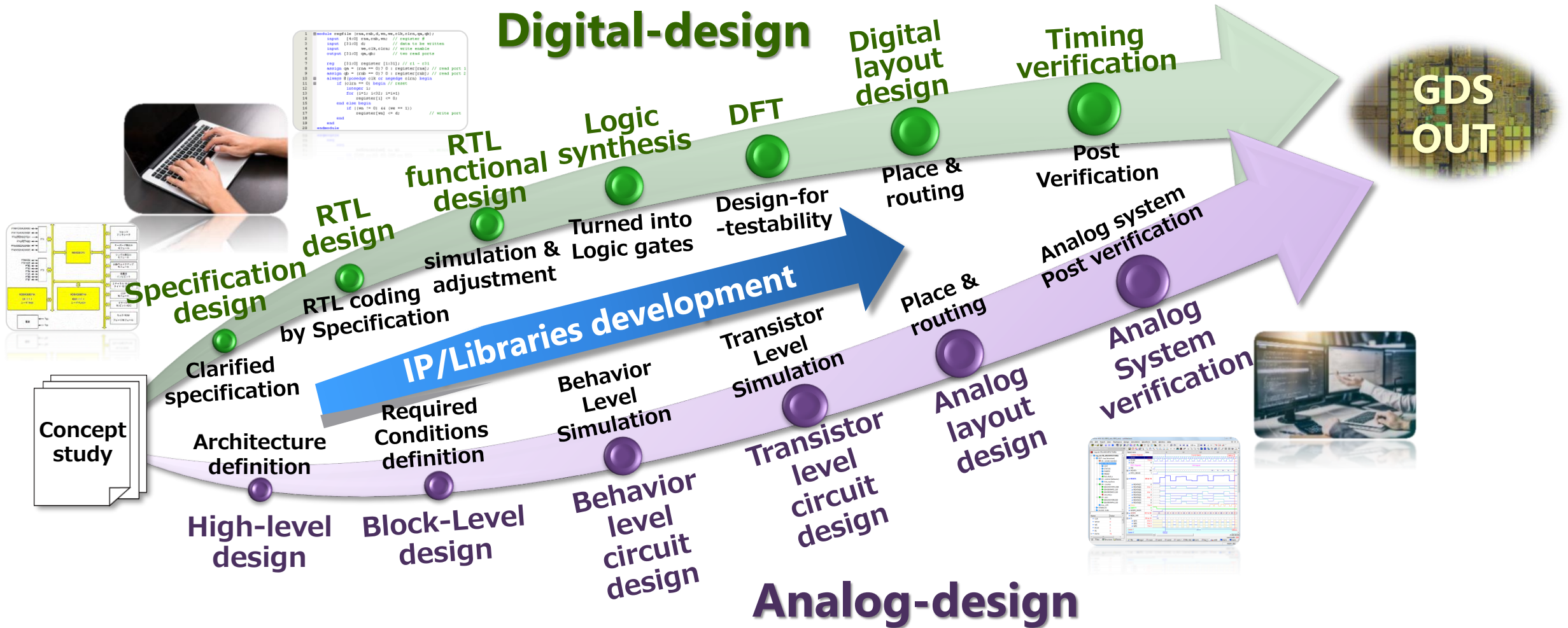


# Design Services -LSI design development flow-

## LSI design and IP/libraries development

### ▶ LSI design development flow



# Design development (LSI products)

## LSI design and IP/libraries development

### ▶ Digital design engineering

#### ◆ Proposals for design development flows and design engineering of LSI products

Entire processes from specifications design to implementation are supported by abundant LSI development expertise cultivated as IDM<sup>(\*1)</sup>.

Latest design method and know-how contribute to designs development with short TAT.

#### ◆ LSI development results

##### Development results

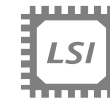
Abundant development results by fabrication, advanced process, VLSI, and high frequency

- Fabrication SEC<sup>(\*2)</sup>, TSMC<sup>(\*3)</sup>, UMC<sup>(\*4)</sup>, GF<sup>(\*5)</sup>, and JSC<sup>(\*6)</sup>
- Process To 5 nm
- Scale 150 M gates
- Frequency 1GHz

##### Abundant LSI development results



Image processing



Micro controllers  
(Arm®/DSP)



MFPs  
(Control chips)



Road traffic system  
(Automotive LSIs)



Memory cards  
(Internal bridge circuits)



Image sensors  
(Image processing control)

(\*1) IDM: Integrated Device Manufacturer (\*2) SEC: Samsung Electronics Co., Ltd.

(\*3) TSMC: Taiwan Semiconductor Manufacturing Company Limited (\*4) UMC: United Microelectronics Corporation

(\*5) GF: GlobalFoundries (\*6) JSC: Japan Semiconductor Corporation

\* Arm is registered trademarks of Arm Limited (or its subsidiaries) in the US and/or elsewhere.

\* All other company names, product names, and service names may be trademarks of their respective companies.

# Design development (LSI products)

## ▶ Analog design engineering

### ◆ Libraries development results

#### Process support results

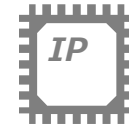
Abundant results by fabrication and advanced process

- Fabrication SEC<sup>(\*1)</sup>, TSMC<sup>(\*2)</sup>, UMC<sup>(\*3)</sup>, and JSC<sup>(\*4)</sup> (CMOS, CD, BiCD)
- Process To 16nm
- Related products SoC, ASIC, linear sensors, area sensors

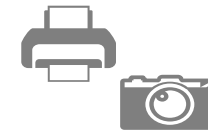
#### Abundant development results



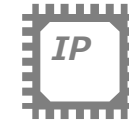
Automotive products



IPs for microcontrollers



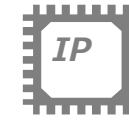
Consumer MCDs



IPs for RF (high frequency)



Memory cards



GPIO, PLL  
Oscillators, ADC,  
and DAC

(\*1) SEC: Samsung Electronics Co., Ltd. (\*2) TSMC: Taiwan Semiconductor Manufacturing Company Limited  
(\*3) UMC: United Microelectronics Corporation (\*4) JSC: Japan Semiconductor Corporation  
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